

Product features

Spot supply, clearly priced.

Adopting MM structure, the product has small parasitic parameters and a frequency of up to 100GHz.

Surface pure gold electrode, suitable for micro assembly processes such as gold wire and gold ribbon.

Suitable for Au/Sn, Au/Si, Au/Ge eutectic soldering, as well as Sn/Pb and conductive adhesive bonding.

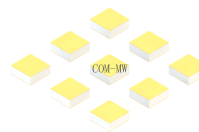
Main specifications

Parameters	Min	Typical	Max	Units
Capacitance value		8.2		PF
Capacitance error		±0.5		PF
Withstand voltage		100		V
Operation Temp.	-55	~	+125	°C
IL		0.25		dB@18GHz
IL		0.5		dB@40GHz

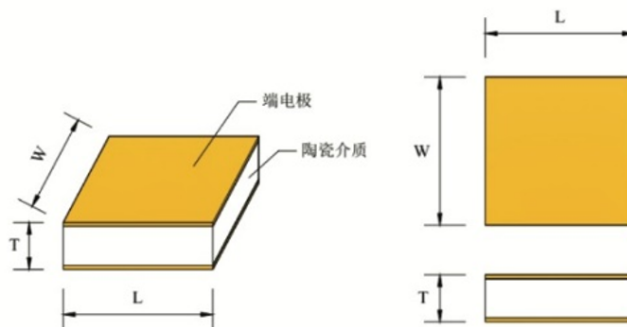
Other parameters

Quality Grade	Industrial grade
ROHS	Compliant Available
Other	Ceramic materials

Reference picture



Configuration(mm)



Size Code	size	Units
L	0.254±0.076	mm
W	0.254±0.076	mm
T	0.178±0.05	mm